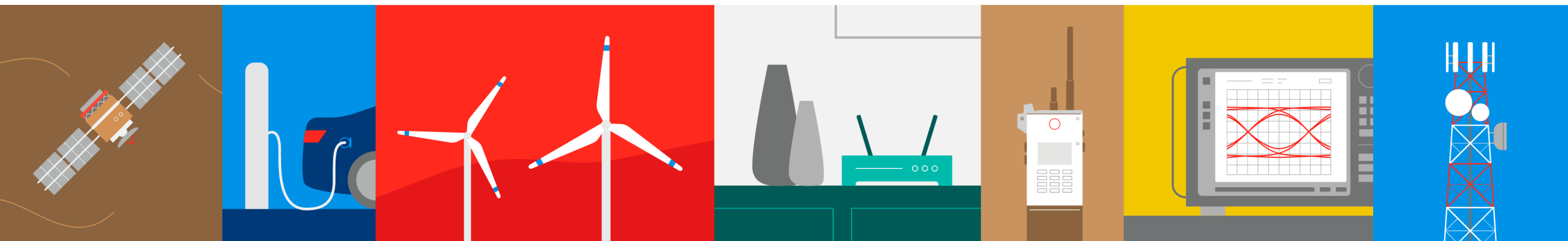


The Impact of MEMS-based RF Multiplexers for Next-Generation Test Systems

March 19, 2024



The Impact of MEMS-based RF Multiplexers for Next-Generation Test Systems

Panelists

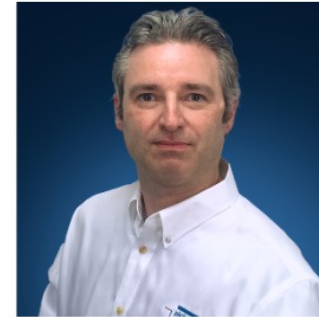
The Impact of MEMS-based RF Multiplexers for Next-Generation Test Systems



Presented by:
Stewart Yang
Sr. RF Systems Applications Engineer,
Menlo Microsystems



March 19, 2024
8am PT / 11am ET



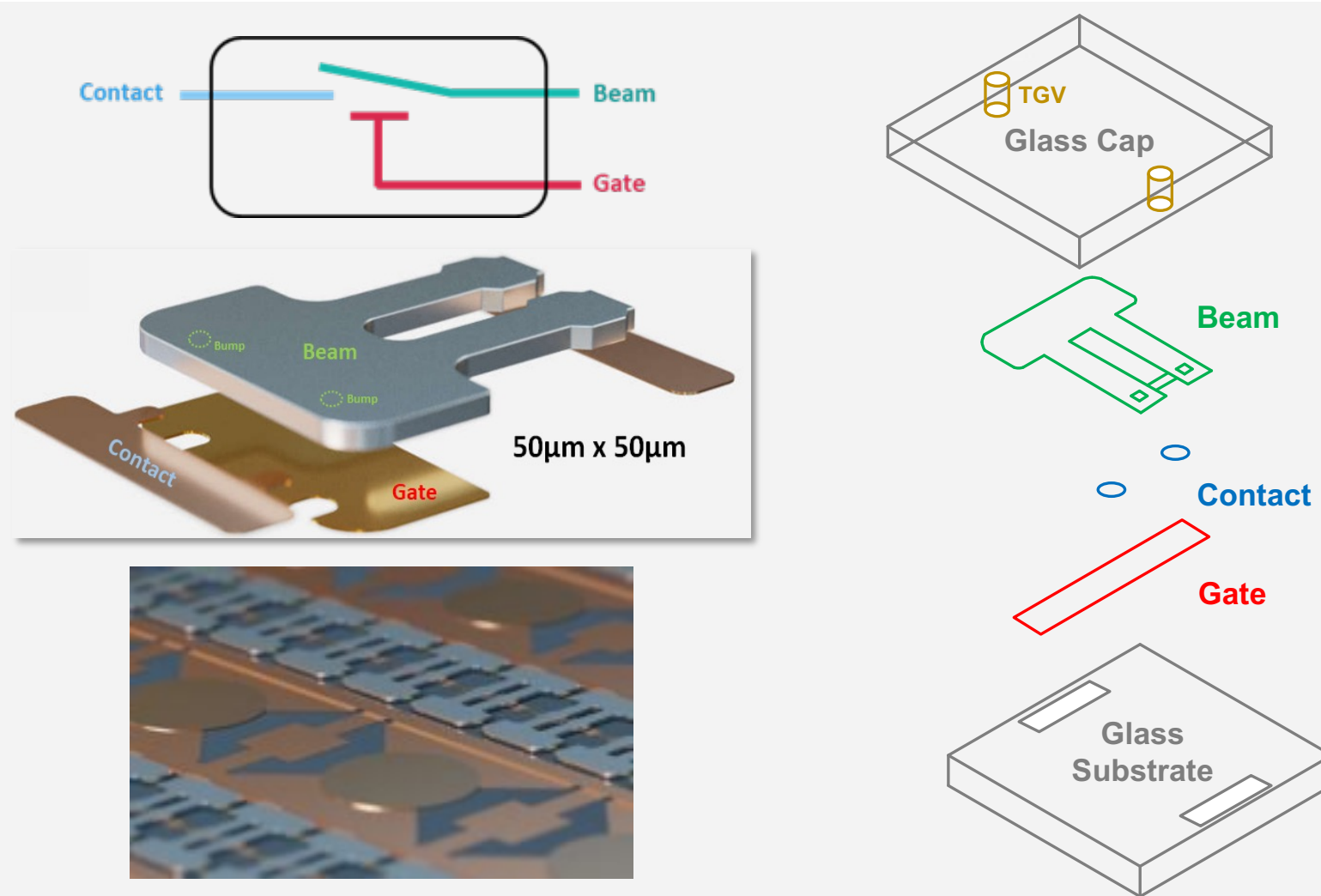
Presented by:
Steven Edwards
Switching Product Manager,
Pickering Interfaces

Organized by:

GlobalSpec

How Ideal Switch® Works – The Unit Cell

Technology platform with breakthrough innovations in materials and processing



Unique Glass Packaging

Improved RF & thermal performances
High RF power handling

Through-Glass-Via

Low parasitics and resistance
Small-size package

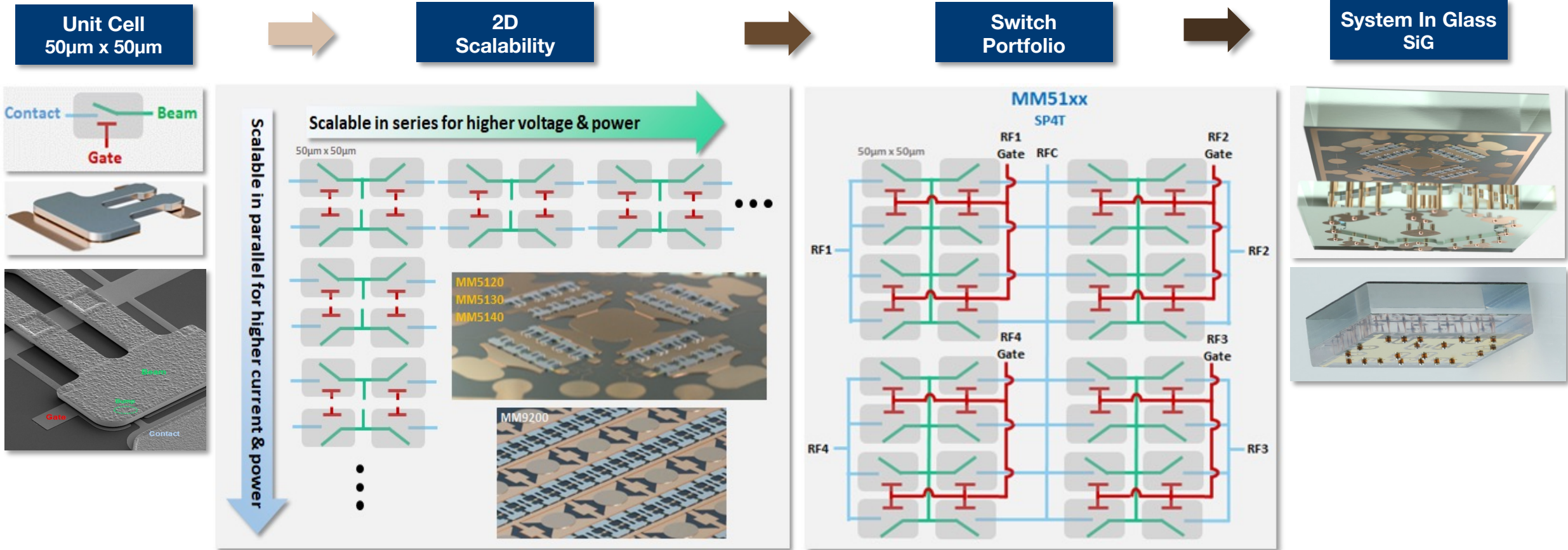
High Reliability

>3B switching cycles
Hermetic-sealed package

Scalability

50µm x 50µm (unit cell)
Scalable switch arrays for high voltage, high current, high power

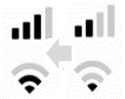
Scalable Switch Arrays With Ideal Switch®



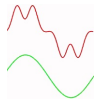
Advantages of Ideal Switch®



- **High RF power handling** – up to 25 W (CW) /150 W (Pulsed)
vs solid-state



- **Low insertion loss** – less than 1 dB
vs solid-state



- **High linearity** – unmatched >90 dBm IP3
vs solid-state and electromechanical



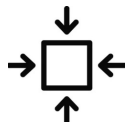
- **Fast Switching** – less than 20 μ s
vs electromechanical



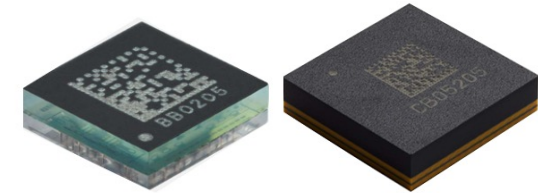
- **Long life** – minimum 3 billion switch cycles
vs electromechanical



- **Low DC power** – from 0.1 mW to less than 10 mW
vs electromechanical and solid-state



- **Small size** – from 6 mm² to 22 mm² footprint
vs electromechanical



Low Cost of Ownership

Product Portfolio – High Frequency



	RF & Microwave			High-Speed Digital		
Model	MM5130	MM5120	MM5140	MM5600	MM5620	MM5622
Markets	Telecommunication, Wireless Aerospace & Defense, Test & Measurements			Semiconductor Test & Measurement, Automated Test Equipment, Aerospace & Defense Equipment		
Applications	Tunable & Programmable Filters, High-Power Low-Loss RF Switch Matrices, Programmable RF Beam Steering			High-Speed Digital SoC Loopback Testing, PCIe, DDR5, MIPI, USB-C, High-Speed Ethernet		
Switch Type	SP4T			DPDT	2x DP3T Diff AC Coupled	2x DP3T Diff DC Coupled
Frequency Range	DC – 26 GHz	DC – 18 GHz	DC – 8 GHz	40 Gbps	64 Gbps	64 Gbps
RF Power	25 W (CW), 150 W (pulsed)			---		
Insertion Loss	0.4 dB @ 6 GHz	0.4 dB @ 6 GHz	0.3 dB @ 3 GHz	1.3 dB @ 10 GHz	2.3 dB @ 16 GHz	2.3 dB @ 16 GHz
Linearity (IP3)	>90 dBm			---		
Control	Direct	SPI/GPIO	SPI/GPIO	Serial to Parallel I/F	SPI/GPIO	SPI/GPIO
DC Supply	89 V (gate)	3.3 V (control), 5 V (V _{CP})	3.3 V (control), 5 V (V _{CP})	5 V (control), 89 V (gate)	3.3 V (control), 5 V (V _{CP})	3.3 V (control), 5 V (V _{CP})
Lifetime	>3B cycles			> 3B cycles		
Package	2.5 mm x 2.5 mm WLCSP	5.2 mm x 4.2 mm LGA		8 mm x 8 mm LGA	8.2 mm x 8.2 mm LGA	8.2 mm x 8.2 mm LGA
Availability	In production			In production		Samples: Q2 2024 Production: Q3 2024

Product Portfolio – Signal Relay and Power



	Signal Relay	Drivers and Smart Power	
Model	MM1205	MM101	MM9200
Markets	Test & Measurement, Wireless Charging, Scientific & Medical, Telecommunication	All	Industrial Automation, Sustainable Buildings Transport Electrification, Solid-State Circuit Breaker & Relay
Applications	High-Density Switch Matrices, Test & Measurement, Mechanical & PhotoMOS Replacement	All	LV Industrial Controls Solid-State & Electromechanical Relay Replacements
Switch Type	6x SPST	High voltage CP & 8-channel driver	SPST
DC Current	1 A per channel, 2 A per device		10 A (AC or DC), 10 mΩ
DC Carry/Standoff Voltage	30 V/100 V	---	300 V (AC or DC)
Frequency Range	DC – 3 GHz	---	---
Control	SPI/GPIO	SPI/GPIO	Direct
DC Supply	3.3 V (control), 5 V (V _{CP})	3.3 V (control), 5 V (V _{CP})	90 V (gate)
Lifetime	>3B cycles	---	1B cycles
Package	8 mm x 8 mm LGA	5 mm x 5 mm QFN 1.6 mm x 2.4 mm WLCSP	5 mm x 5 mm WLCSP 6 mm x 6.5 mm QFN
Availability	In production	In production	Samples: Available Production: Q4 2024

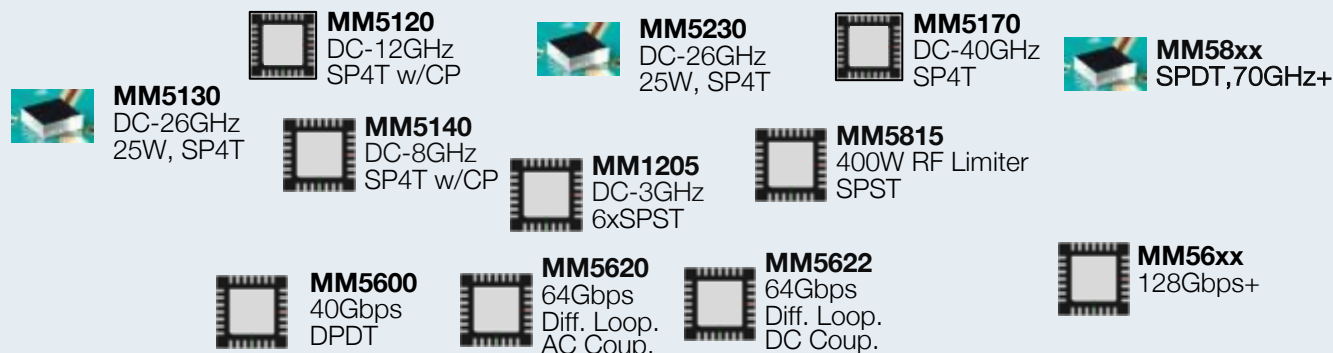
Product Roadmap

Driving and accelerating product roadmap from customers applications

Current Product Portfolio

Future Product Roadmap

RF & MICROWAVE SWITCHES



- Higher frequency, isolation
- Smaller form factor
- Higher reliability

HIGH SPEED DIGITAL SWITCHES

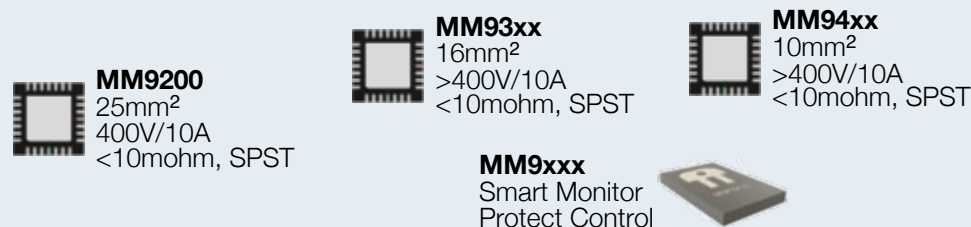
- Higher data rate (beyond PCIe 6...)
- Smaller form factor, higher density
- Custom/multichip switch configurations

RF & MICROWAVE REFERENCE DESIGNS



- System-in-package (SiP) heterogeneous integration with RF/digital/mixed signal ICs
- 3D glass integration with passive devices

SMART AC/DC POWER SWITCHING



- Higher voltage & current
- Smaller die size: higher power density & lower Ron/mm²
- Integrated smart protection devices with embedded sensing and control

Website Resources – Menlo Micro and GlobalSpec

Additional product support and documentation on website

- Users can sign up by clicking on “Login” and then “Request Access”

<http://www.menlomicro.com>

- Access Menlo’s product information through GlobalSpec website

<https://www.globalspec.com/supplier/profile/MenloMicro>



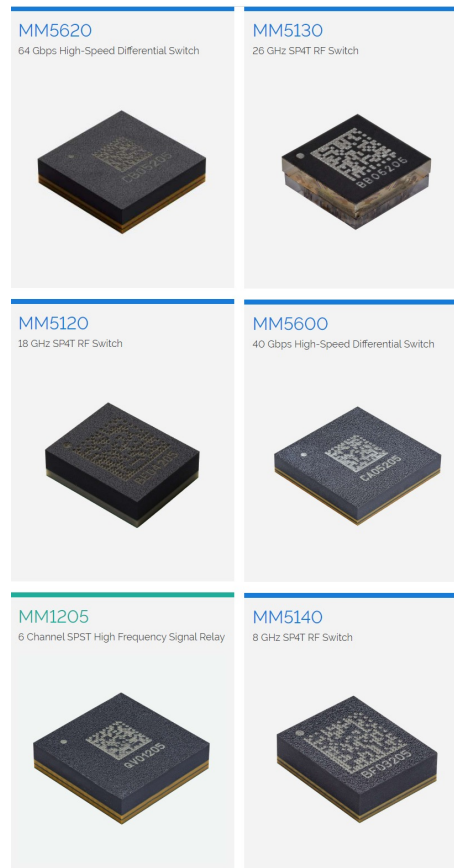
Resources

What's New

Video Tutorials

All Products >

RF Switches



HOME > PRODUCTS & SERVICES > DIRECTOR



Menlo Microsystems, Inc.

Contact Information

Profile Home

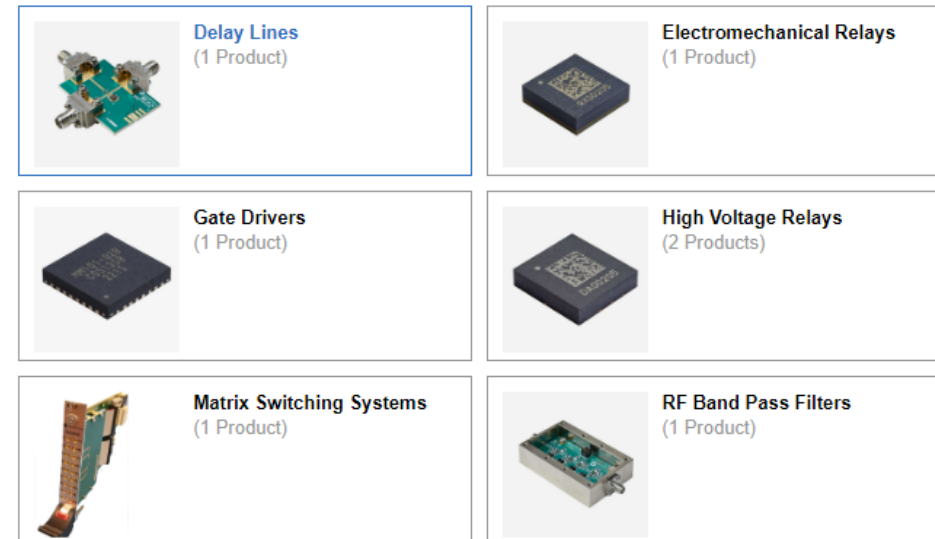
Request Information

Product Catalog

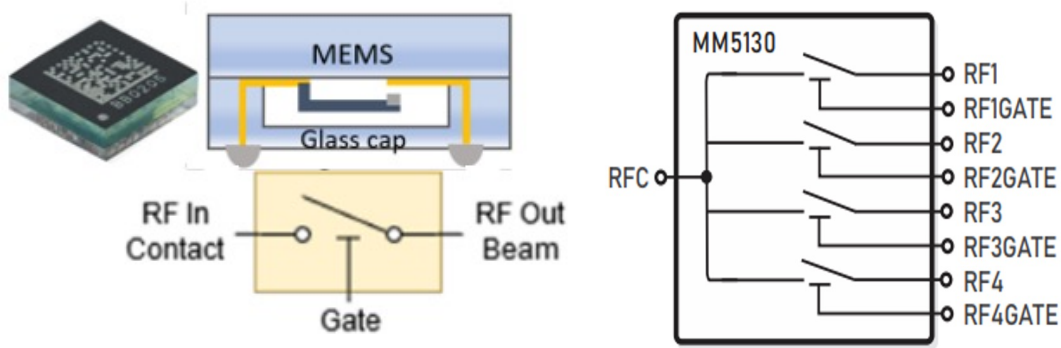
Announcements

Technical Articles

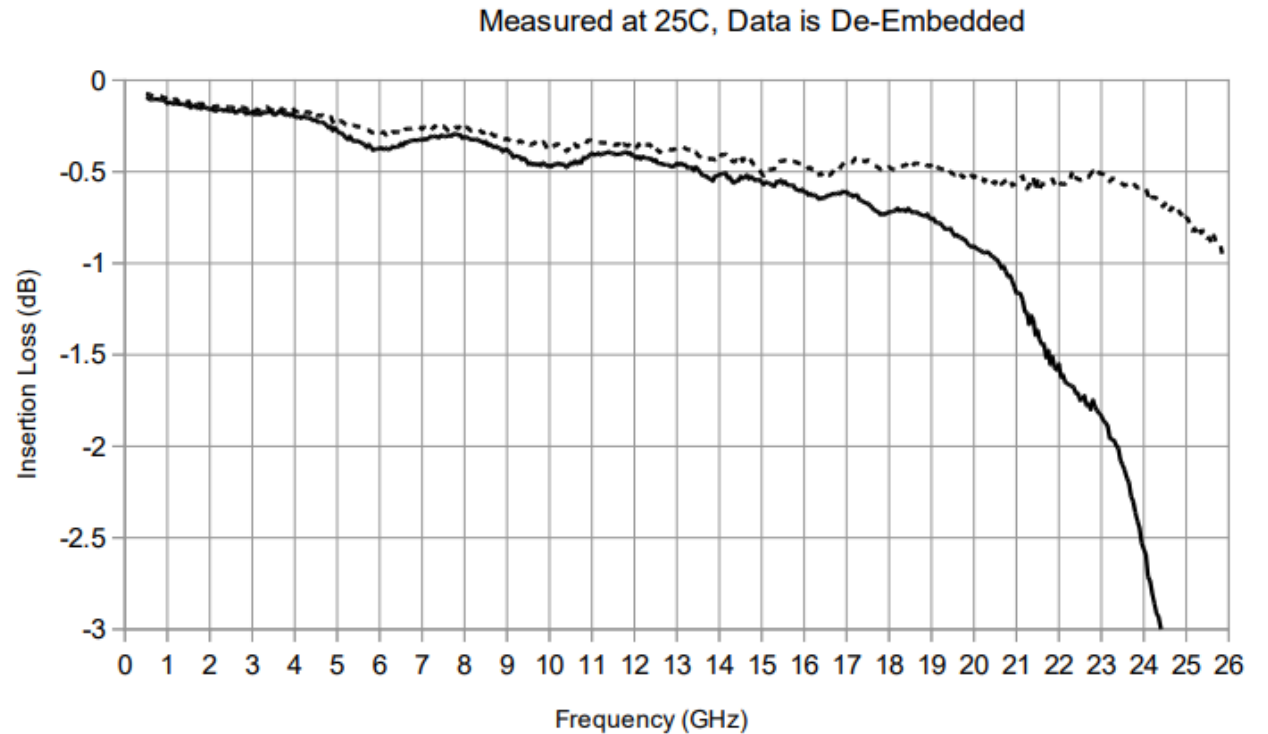
Product Catalog



MM5130 – DC to 26 GHz High Power RF Switch



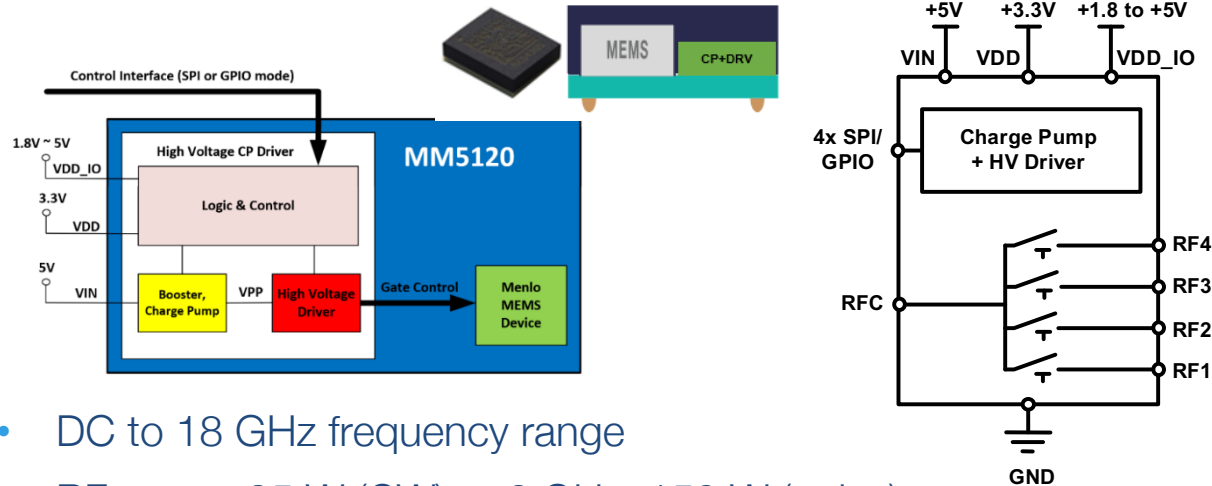
- DC to 26 GHz (super-port) and 18 GHz (standard-port) frequency range
- RF power 25 W (CW) to 6 GHz, 150 W (pulse)
- High linearity IP3 >90 dBm
- <0.8 dB on-state insertion loss @ 18 GHz (super port)
- High reliability >3B switching cycles guarantee
- 2.5 mm x 2.5 mm WLCSP
- Key Application: Test and measurement, aerospace & defense, tunable filters, switch filter bank, antenna tuners, phase shifters, time delay units, digital attenuators



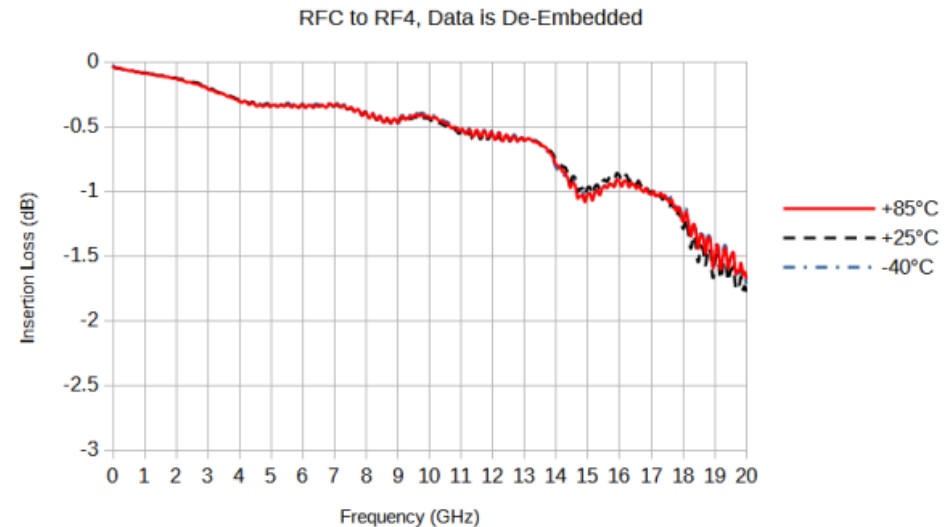
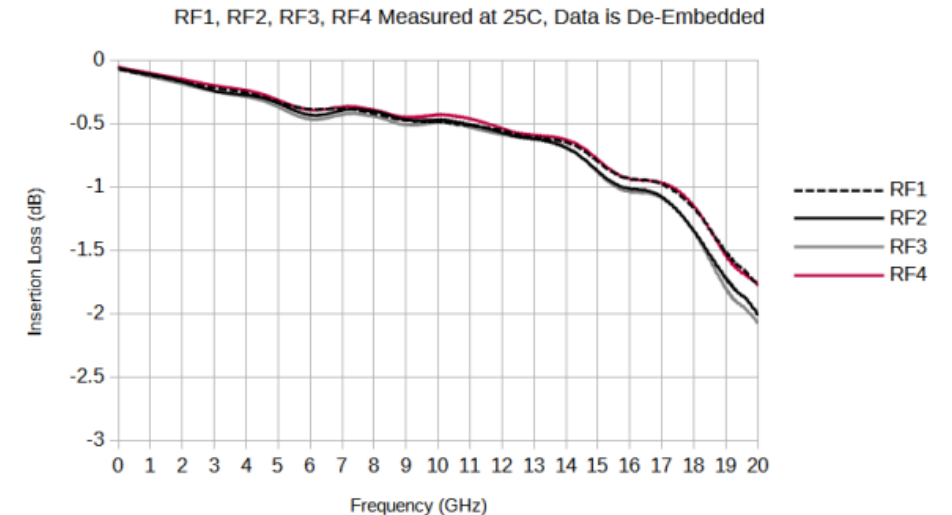
Insertion Loss (Super-Port Configuration)

[Menlo MM5130 Datasheet \(menlomicro.com\)](https://www.menlomicro.com/datasheet/MM5130)

MM5120– DC to 18 GHz SP4T RF Switch



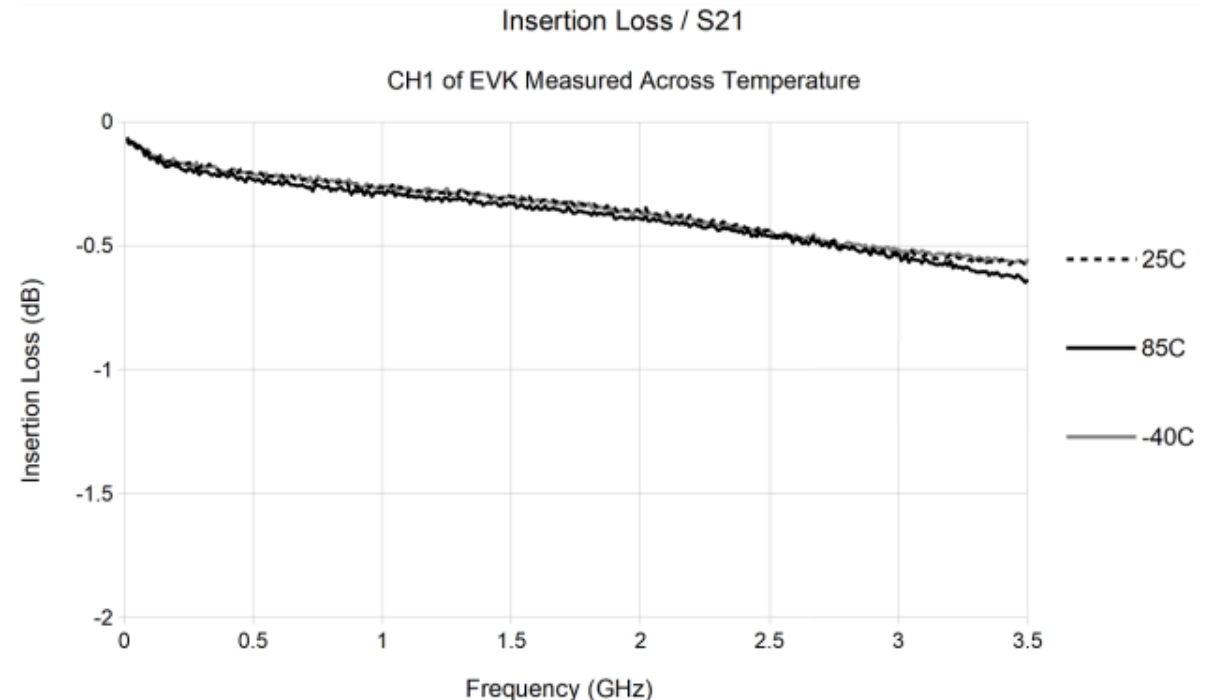
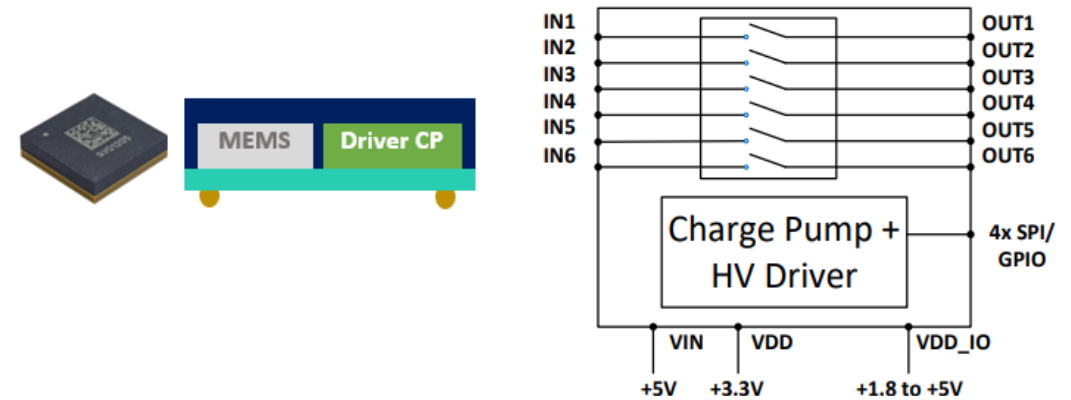
- DC to 18 GHz frequency range
- RF power 25 W (CW) to 6 GHz, 150 W (pulse)
- High linearity IP3 >90 dBm
- 0.7 dB on-state insertion loss @ 12 GHz
- Integrated high-voltage driver
- High reliability >3B switching cycles
- 5.2 mm x 4.2 mm LGA
- Key Applications: Test and measurement, aerospace & defense, tunable filters, switch filter bank, antenna tuners, phase shifters, time delay units, digital attenuators, and network I/O modules, high-performance RF switching.



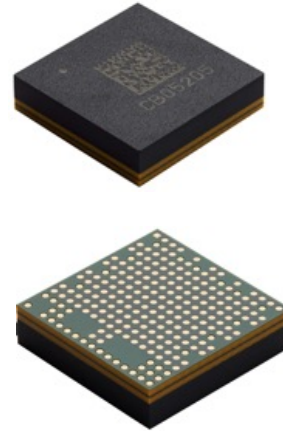
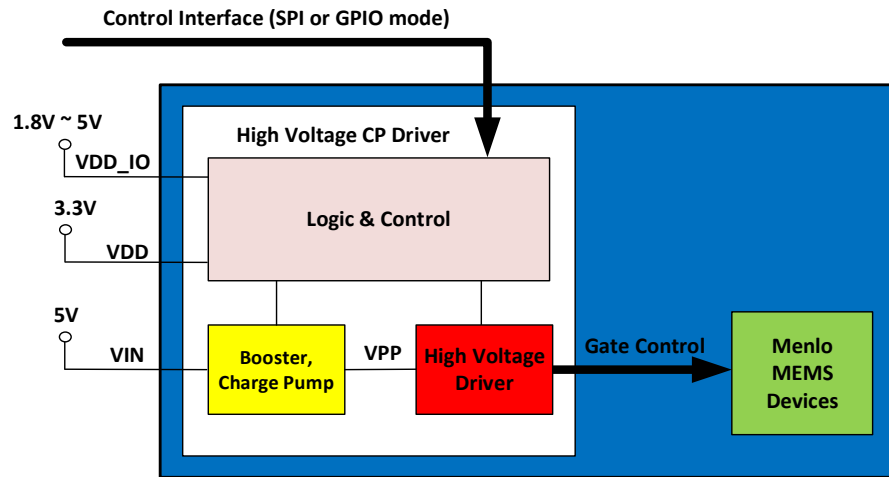
MM1205 – 6 Channel SPST High Frequency Signal Relay

- DC to 3 GHz frequency range
- 1 A per channel on-state DC carry current, 2 A per package
- Up to 30 V per-channel on-state DC carry voltage
- ~1.0 Ω on-state resistance (per channel)
- RF power 25 W (CW) to 300 MHz, 2000 W (pulsed)
- Low on-state insertion loss 0.5 dB @ 3 GHz
- 17 dB input to output off-state isolation @ 3 GHz
- Switching + settling time 17 μ s
- Integrated high-voltage driver
- High reliability >3B switching cycles
- 8 mm x 8 mm LGA package
- Key Applications: Test & Measurement, Broadcasting and Audio-Visual Equipment, Network I/O Relay Module

[Menlo MM1205 Datasheet \(menlomicro.com\)](https://www.menlomicro.com/datasheet/MM1205)

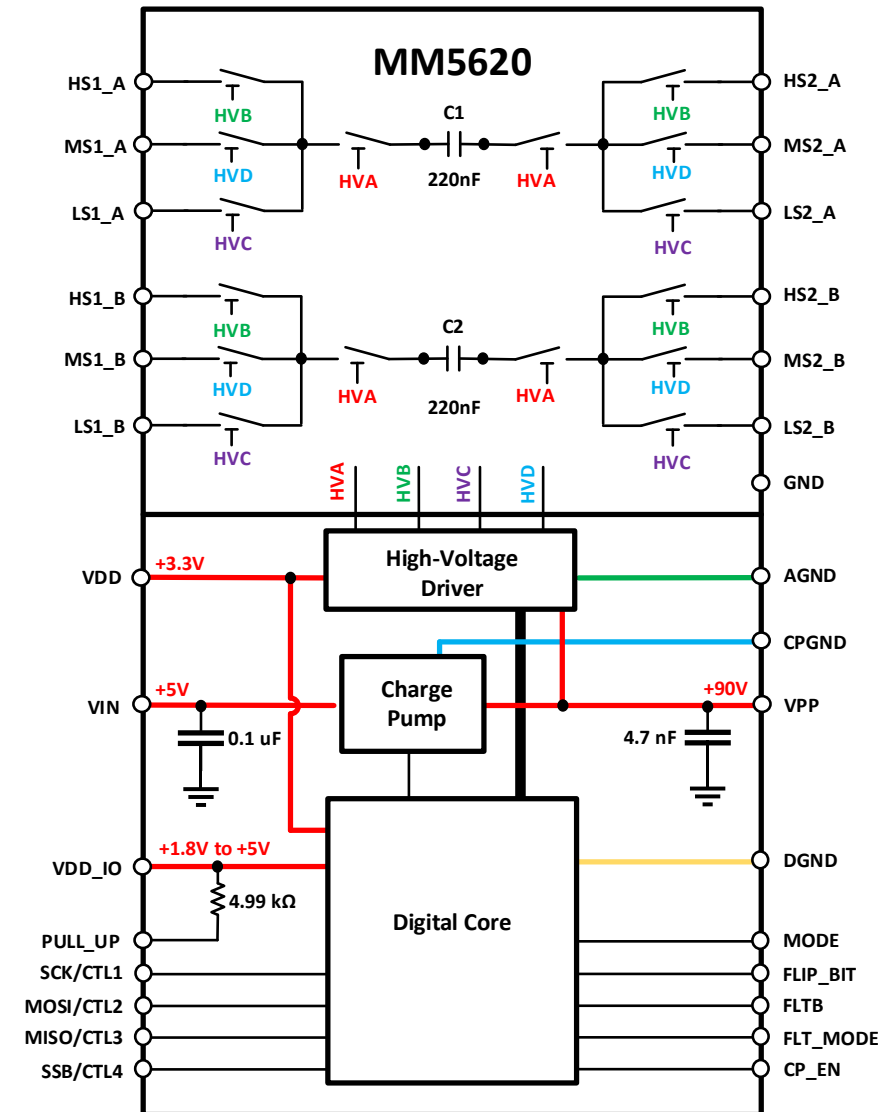


MM5620/MM5622 – 64 Gbps High-Speed Differential Switch



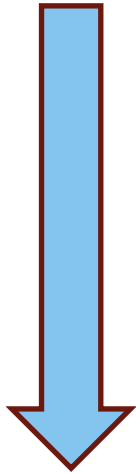
- Dual DP3T Differential Loopback Mode
- DC to 20 GHz range, support 64 Gbps
- Optimized for PCIe Gen 5 & 6, SerDes
- Integrated high-voltage driver
- High reliability >3B switching cycles
- 8.2 mm x 8.2 mm LGA
- Key Application: Test and measurement
- Road map: Smaller form factor, greater than 128 GT/s

[Menlo MM5620 Datasheet \(menlomicro.com\)](https://menlomicro.com)

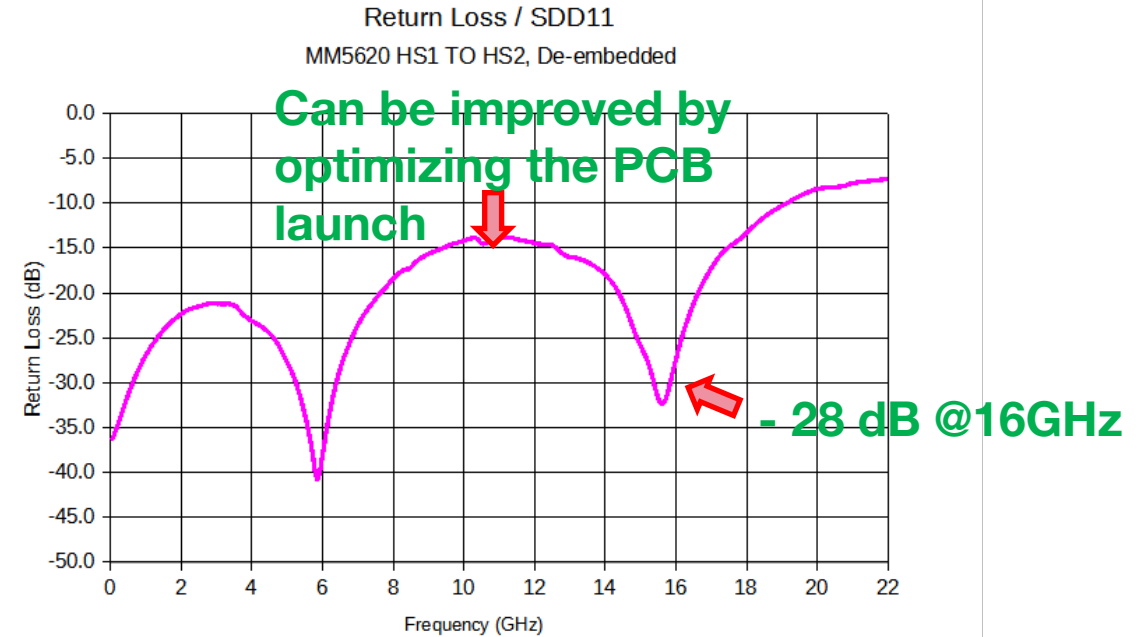
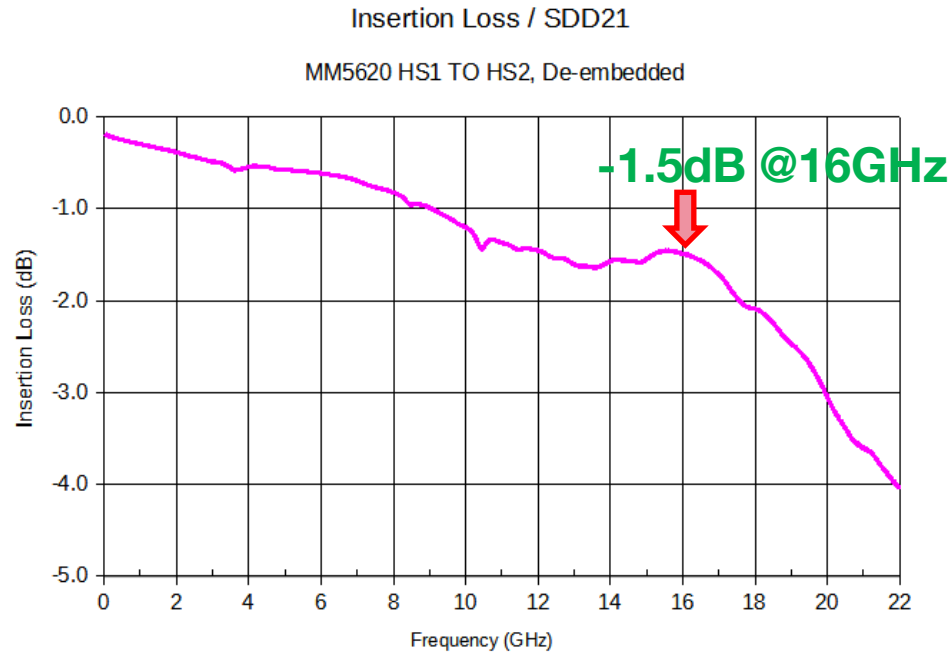


MM5620 S-Parameter Performance (HS1 to HS2 Signal Path)

Frequency
Domain
Analysis

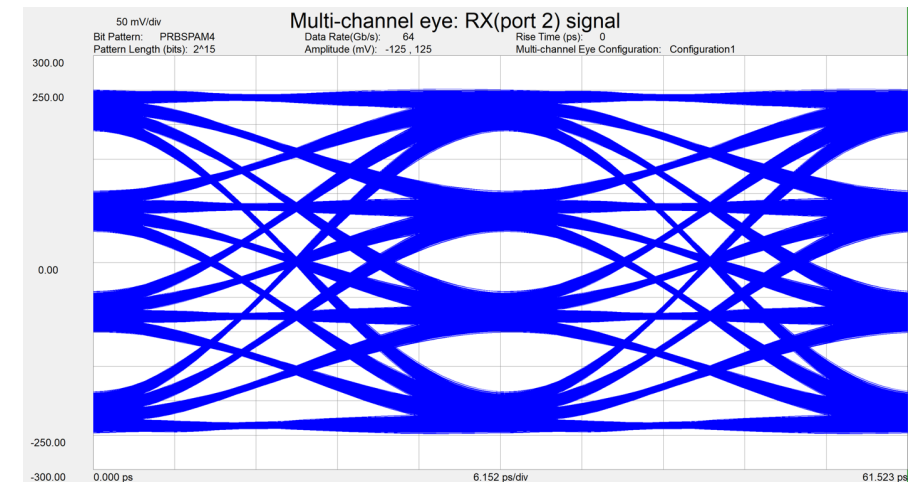


Time
Domain
Analysis

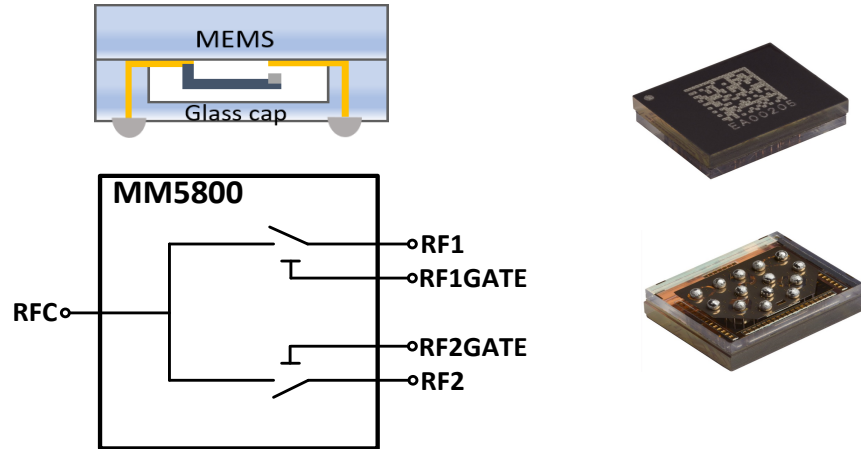


Eye-Diagram Test Conditions

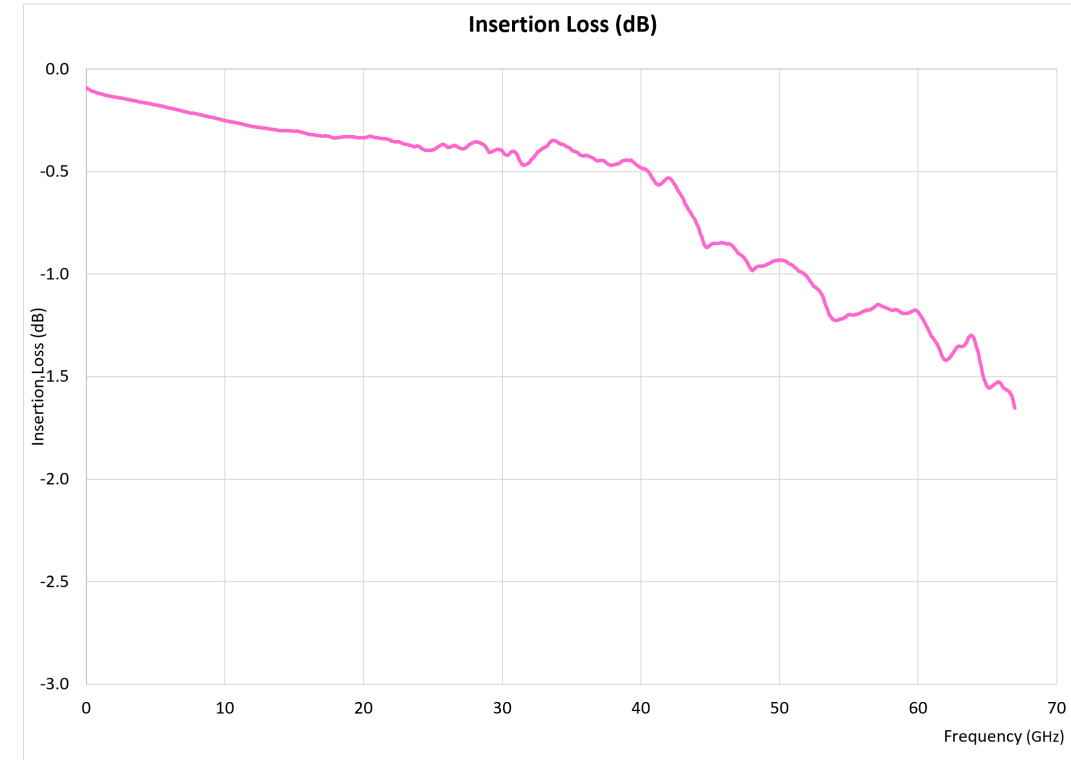
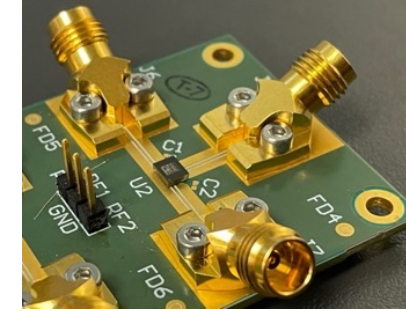
- PCIe Gen6
- PAM4, 32 Gbaud (64Gbps), PRBS $2^{15}-1$
- 500mVpp (+250 mV/-250mV)



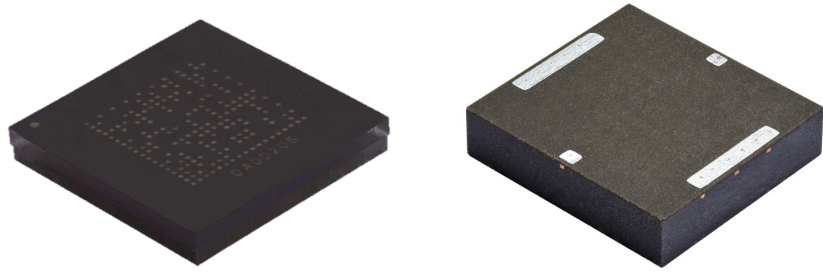
MM5800 - 70 GHz SPDT Millimeter Wave Switch



- Single SPDT: Small WL-CSP package
- Low-loss: 0.5dB @ 40 GHz
- High Isolation: 30 dB @ 40 GHz
- High Reliability: >3B switch cycles
- Key Application: Test and measurement

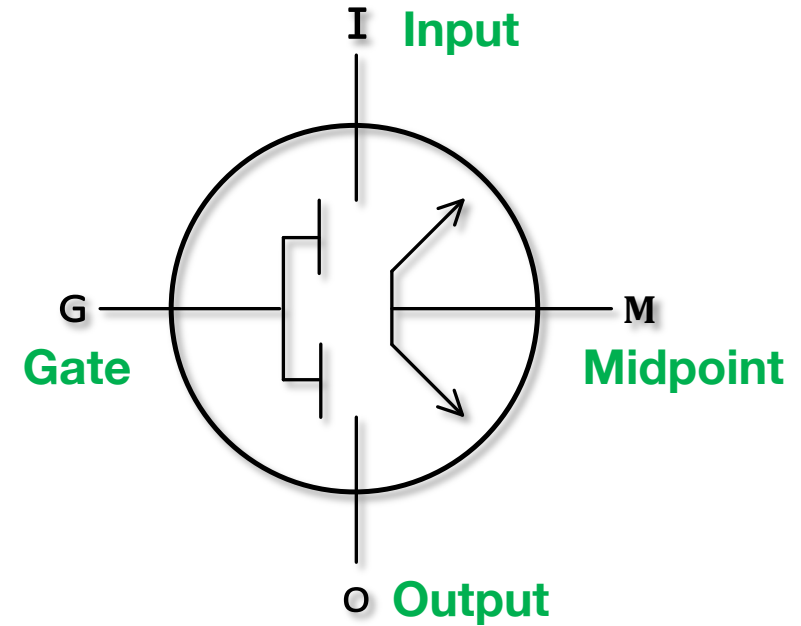


MM9200 – 300V/10A SPST Power Switch



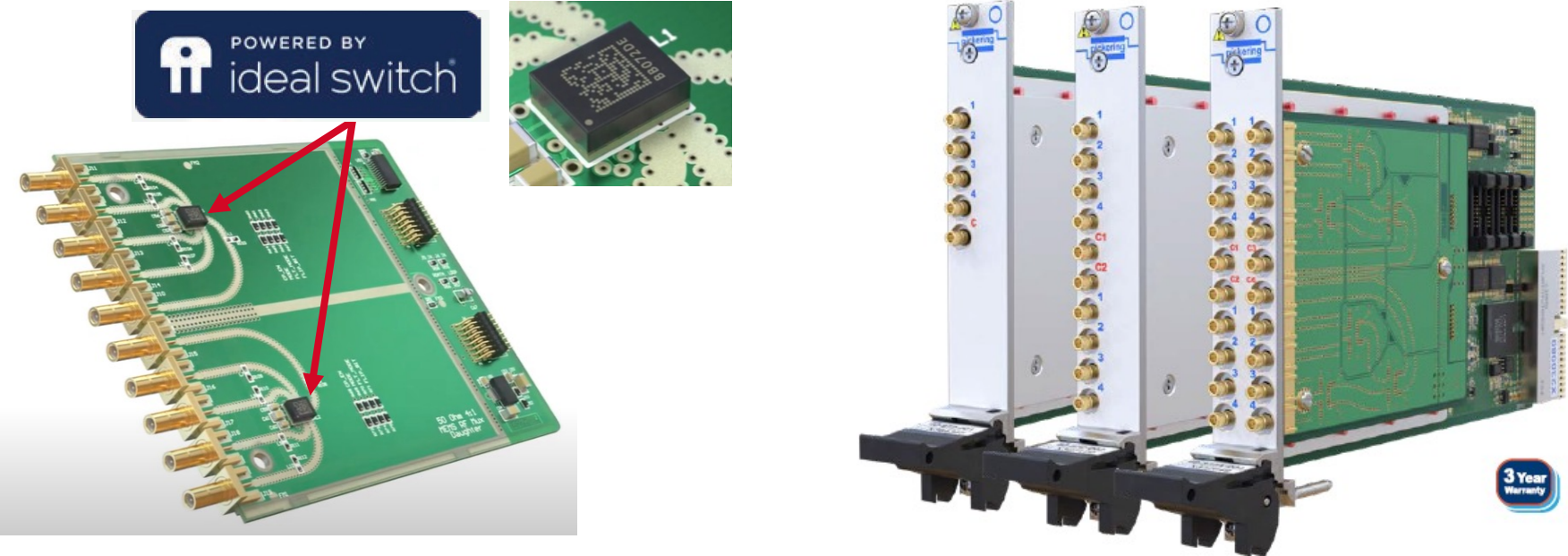
- Low On-State resistance: < 10 mΩ over full temp range
- Off-State Contact Leakage Current: 5 pA (typical)
- Voltage standoff (AC peak or DC): 300V
- Rated continuous current (AC or DC): 10A RMS
- Fast switching time: 10μs to open, 10μs to close
- Low-profile 6.5 mm x 6.0 mm QFN package
- Key Application: Replacement of EMR & solid-state relays, solid state circuit breakers. Load controllers for buildings

[Menlo MM9200 Product Brief \(menlomicro.com\)](https://menlomicro.com)



Pin Name	Description
GATE (G)	Gate control to turn switch on/off, referenced to MIDPOINT pin.
MIDPOINT (M)	Beams Reference
INPUT (I)	Switch Input Pin
OUTPUT (O)	Switch Output Pin

Pickering – PXI/PXIe 50 Ω 4-Channel RF MEMS Multiplexers



One Slot



Performance Characteristics

What does the Pickering 40/42-878 offer to the user?

- **Speed of operation** (50 us)
 - EMR solutions, 3 ms (MEMS, 60x faster)
- **Long service life** (>3 Billion operations)
 - EMR solutions, 10 Million (MEMS, 300x improvement)
- **Very low insertion loss** (<1.4 dB to 4 GHz)
- **Increased frequency** (4 GHz Bandwidth)
 - EMR solutions, 3 GHz
- **Test system implications:**
 - Increases throughput
 - Minimizes downtime
 - Future-proofing



Technology Comparisons

How does MEMS compare to alternate RF Solutions?

Typical Characteristics

MEMS:

Best fit for long life, cold switch only with good RF characteristics (insertion loss, signal integrity), and best power handling capability.

EMR:

Best for general purpose, cost-effective, decent life, better tolerance to hot switching, good RF characteristics, and power handling capability.

Solid State:

Best for long (indefinite) life when used to spec, AC signals only, some hot switching, a high insertion loss, and low power handling capability.

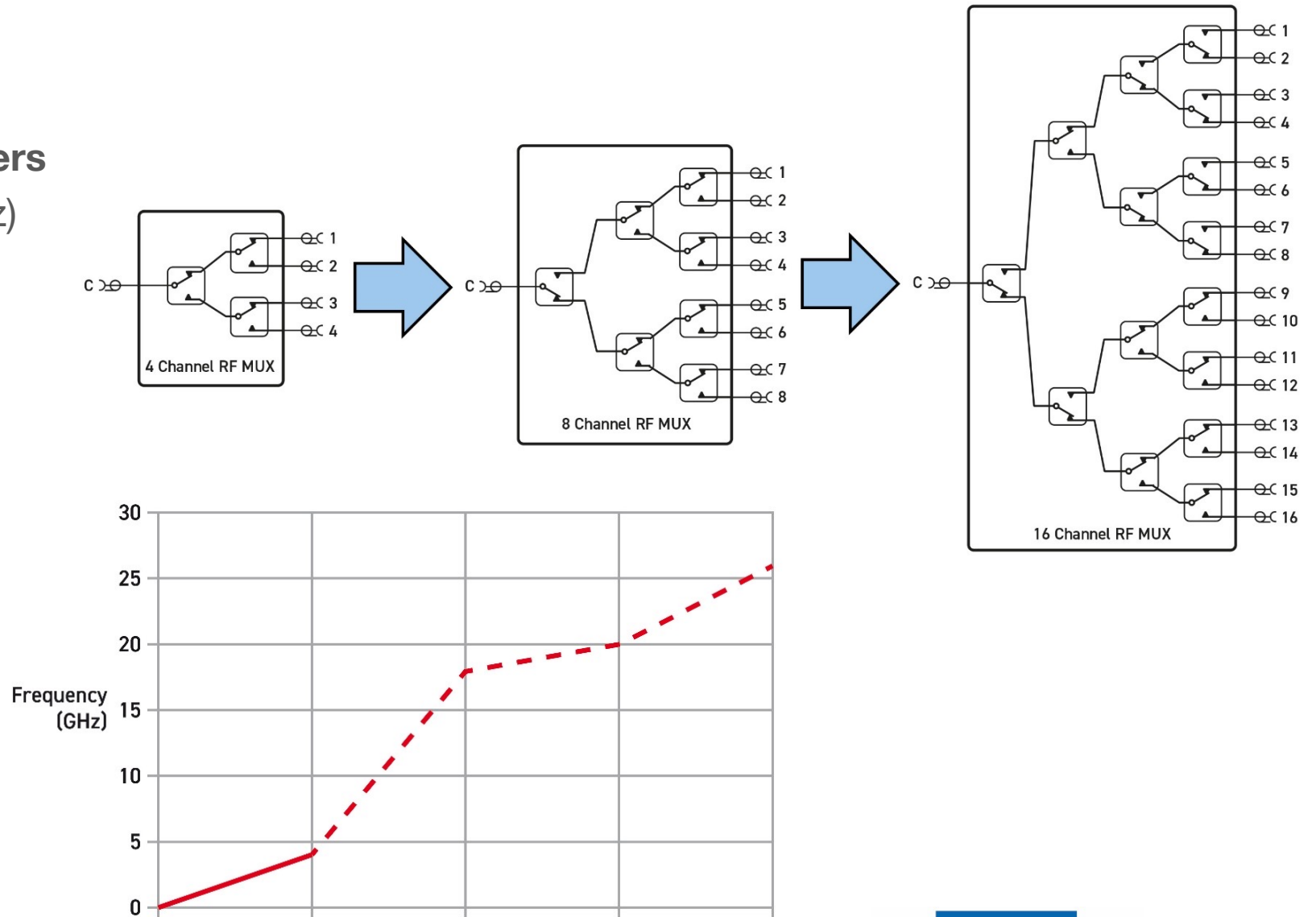
*All specifications relate to specific Pickering PXI & PXIe products.

	MEMS	EMR	Solid State
Frequency Range	DC to 4 GHz (usable to 5 GHz)	DC to 3 GHz	10 MHz to 8 GHz
Insertion Loss	<1.4 dB to 4 GHz	<1.0 dB to 3 GHz	<6.0 dB to 8 GHz
VSWR	<1.5:1 to 4 GHz	<1.4:1 to 3 GHz	<1.95:1 to 8 GHz
Max RF Power	25 W to 4 GHz	10 W at 3 GHz	4 W at 8 GHz
Operating Time	50 microseconds	3 milliseconds	50 microseconds
Life Expectancy	3 billion operations	10 million operations	Indefinite
Hot Switching	None	Better tolerance	Some tolerance
Price per channel normalized to EMR	1.3	1	1.9

Potential Developments

What Does The Future Hold?

- **Higher channel count multiplexers**
- **Alternate frequencies** (to 26 GHz)
- **Additional topologies**
 - Uncommitted
 - Matrix
 - Fault insertion
- **New applications**
 - Differential switching



Thank you.